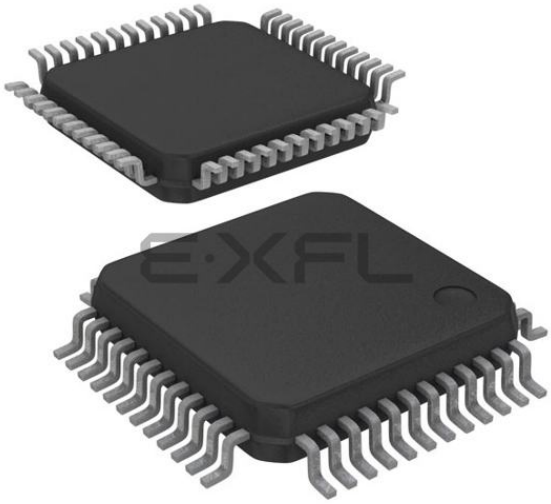


Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	RXv2
Core Size	32-Bit Single-Core
Speed	54MHz
Connectivity	CANbus, I²C, IrDA, SCI, SD/SDIO, SPI, SSI, USB OTG
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	30
Program Memory Size	512KB (512K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	64K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 8x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LFQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f52318bdfl-30

1. Overview

1.1 Outline of Specifications

Table 1.1 lists the specifications, and Table 1.2 gives a comparison of the functions of the products in different packages.
Table 1.1 is for products with the greatest number of functions, so the number of peripheral modules and channels will differ in accordance with the package type. For details, see Table 1.2, Comparison of Functions for Different Packages.

Table 1.1 Outline of Specifications (1/4)

Classification	Module/Function	Description
CPU	CPU	• Maximum operating frequency: 54 MHz • 32-bit RX CPU (RX v2) • Minimum instruction execution time: One instruction per clock cycle • Address space: 4-Gbyte linear • Register set General purpose: Sixteen 32-bit registers Control: Ten 32-bit registers Accumulator: Two 72-bit registers • Basic instructions: 75 (variable-length instruction format) • Floating-point instructions: 11 • DSP instructions: 23 • Addressing modes: 10 • Data arrangement Instructions: Little endian Data: Selectable as little endian or big endian • On-chip 32-bit multiplier: 32-bit × 32-bit → 64-bit • On-chip divider: 32-bit ÷ 32-bit → 32 bits • Barrel shifter: 32 bits • Memory protection unit (MPU)
	FPU	• Single precision (32-bit) floating point • Data types and floating-point exceptions in conformance with the IEEE754 standard
Memory	ROM	• Capacity: 128/256/384/512 Kbytes • Up to 32 MHz: No-wait memory access 32 to 54 MHz: Wait state required. No wait state if the instruction is served by a ROM accelerator hit. • Programming/erasing method: Serial programming (asynchronous serial communication/USB communication), self-programming
	RAM	• Capacity: 32/64 Kbytes • 54 MHz, no-wait memory access
	E2 DataFlash	• Capacity: 8 Kbytes • Number of erase/write cycles: 1,000,000 (typ)
MCU operating mode		Single-chip mode, on-chip ROM enabled expansion mode, and on-chip ROM disabled expansion mode (software switching)
Clock	Clock generation circuit	• Main clock oscillator, sub-clock oscillator, low-speed on-chip oscillator, high-speed on-chip oscillator, PLL frequency synthesizer, USB-dedicated PLL frequency synthesizer, and IWDT-dedicated on-chip oscillator • Oscillation stop detection: Available • Clock frequency accuracy measurement circuit (CAC) • Independent settings for the system clock (ICLK), peripheral module clock (PCLK), external bus clock (BCLK), and FlashIF clock (FCLK) The CPU and system sections such as other bus masters run in synchronization with the system clock (ICLK): 54 MHz (at max.) MTU2a runs in synchronization with the PCLKA: 54 MHz (at max.) The ADCLK for the S12AD runs in synchronization with the PCLKD: 54 MHz (at max.) Peripheral modules other than MTU2a and S12ADE run in synchronization with the PCLKB: 32 MHz (at max.) Devices connected to external buses run in synchronization with the BCLK: 32 MHz (at max.) The flash peripheral circuit runs in synchronization with the FCLK: 32 MHz (at max.)
Resets		RES# pin reset, power-on reset, voltage monitoring reset, watchdog timer reset, independent watchdog timer reset, and software reset
Voltage detection	Voltage detection circuit (LVDAb)	• When the voltage on VCC falls below the voltage detection level, an internal reset or internal interrupt is generated. Voltage detection circuit 0 is capable of selecting the detection voltage from 4 levels Voltage detection circuit 1 is capable of selecting the detection voltage from 14 levels Voltage detection circuit 2 is capable of selecting the detection voltage from 4 levels

Table 1.8 List of Pins and Pin Functions (64-Pin WFLGA) (1/2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, TPU, TMR, RTC, CMT, POE, CAC)	Communications (SCI, RSPI, RIIC, RSCAN, USB, SSI)	Memory Interface (SDHI)	Touch sensing	Others
A1		P05					DA1
A2	AVCC0						
A3	VREFH0						
A4	VREFL0						
A5	VREFH						
A6	VREFL						
A7		PE2	MTIOC4A	RXD12/RXDX12/SMISO12/ SSCL12			IRQ7/AN018/ CVREFB0
A8		PE3	MTIOC4B/POE8#	CTS12#/RTS12#/SS12#/ AUDIO_MCLK			AN019/CLKOUT
B1	VCL						
B2	AVSS0						
B3		P40					AN000
B4		P42					AN002
B5		P44					AN004
B6		P46					AN006
B7		PE1	MTIOC4C	TXD12/TXDX12/SIOX12/ SMOSI12/SSDA12			AN017/CMPB0
B8		PE4	MTIOC4D/MTIOC1A				AN020/CMPA2/ CLKOUT
C1	XCIN						
C2	MD						FINED
C3		P03					DA0
C4		P41					AN001
C5		P43					AN003
C6		PE0		SCK12			AN016
C7		PE5	MTIOC4C/MTIOC2B				IRQ5/AN021/ CMPOB0
C8		PA0	MTIOC4A/TIOCA0	SSLA1			CACREF
D1	XCOUT						
D2	RES#						
D3		P27	MTIOC2B/TMCI3	SCK1/ SSIWS0		TS2	CVREFB3
D4		P14	MTIOC3A/MTCLKA/TMRI2/ TIOCB5/TCLKA	CTS1#/RTS1#/SS1#/CTXD0/ USB0_OVRCURA		TS13	IRQ4/CVREFB2
D5		PA6	MTIC5V/MTCLKB/TMCI3/POE2#/ TIOCA2	CTS5#/RTS5#/SS5#/MOSIA/ SSIWS0			
D6		PA4	MTIC5U/MTCLKA/TMRI0/TIOCA1	TXD5/SMOSI5/SSDA5/SSLA0/ SSITXD0/IRTXD5			IRQ5 /CVREFB1
D7		PA1	MTIOC0B/MTCLKC/TIOCB0	SCK5/SSLA2/SSISCK0			
D8		PA3	MTIOC0D/MTCLKD/TIOCD0/ TCLKB	RXD5/SMISO5/SSCL5/SSIRXD0/ IRRXD5			IRQ6 /CMPB1
E1	VSS						
E2	VBATT						
E3		P30	MTIOC4B/TMRI3/POE8#/RTCIC0	RXD1/SMISO1/SSCL1/ AUDIO_MCLK			IRQ0/CMPOB3
E4		P16	MTIOC3C/MTIOC3D/TMO2/ TIOCB1/TCLKC/RTCOUT	TXD1/SMOSI1/SSDA1/MOSIA/ SCL/USB0_VBUS/ USB0_VBUSEN/ USB0_OVRCURB			IRQ6/ADTRG0#
E5		PC4	MTIOC3D/MTCLKC/TMCI1/ POE0#	SCK5/CTS8#/RTS8#/SS8#/ SSLA0	SDHI_D1	TSCAP	
E6	VCC						
E7	VSS						
E8		PB0	MTIC5W/TIOCA3	RXD6/SMISO6/SSCL6/RSPCKA	SDHI_C MD		
F1	VCC						
F2	UPSEL	P35					NMI
F3		P31	MTIOC4D/TMCI2/RTCIC1	CTS1#/RTS1#/SS1#/SSISCK0			IRQ1

Table 1.8 List of Pins and Pin Functions (64-Pin WFLGA) (2/2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, TPU, TMR, RTC, CMT, POE, CAC)	Communications (SCI, RSPI, RIIC, RSCAN, USB, SSI)	Memory Interface (SDHI)	Touch sensing	Others
F4		PC5	MTIOC3B/MTCLKD/TMRI2	SCK8/RSPCKA/USB0_ID			TS23
F5		P15	MTIOC0B/MTCLKB/TMCI2/ TIOCB2/TCLKB	RXD1/SMISO1/SSCL1/CRXD0		TS12	IRQ5/CMPB2
F6		PB1	MTIOC0C/MTIOC4C/TMCI0/ TIOCB3	TXD6/SMOSI6/SSDA6	SDHI_CLK		IRQ4/ CMPOB1
F7		PB5	MTIOC2A/MTIOC1B/TMRI1/ POE1#/TIOCB4	SCK9/USB0_VBUS	SDHI_CD		
F8		PB3	MTIOC0A/MTIOC4A/TMO0/ POE3#/TIOCD3/TCLKD	SCK6	SDHI_WP		
G1	EXTAL	P36					
G2		P26	MTIOC2A/TMO1	TXD1/SMOSI1/SSDA1/ USB0_VBUSEN/SSIRXD0		TS3	CMPB3
G3	VCC_USB*1	PH3*1	TMCI0*1				
G4	VSS_USB*1	PH0*1					CACREF*1
G5	UB	PC7	MTIOC3A/MTCLKB/TMO2	TXD8/SMOSI8/SSDA8/MISOA			CACREF
G6		PC6	MTIOC3C/MTCLKA/TMCI2	RXD8/SMISO8/SSCL8/MOSIA/ USB0_EXICEN		TS22	
G7		PC3	MTIOC4D/TCLKB	TXD5/SMOSI5/SSDA5/IRTXD5	SDHI_D0	TS27	
G8		PB6/PC0	MTIOC3D/TIOCA5	RXD9/SMISO9/SSCL9	SDHI_D1		
H1	XTAL	P37					
H2		P17	MTIOC3A/MTIOC3B/TMO1/ POE8#/TIOCB0/TCLKD	SCK1/MISOA/SDA/SSITXD0			IRQ7/ CMPOB2
H3		PH2*1	TMRI0*1	USB0_DM*1			IRQ1*1
H4		PH1*1	TMO0*1	USB0_DP*1			IRQ0*1
H5		P55	MTIOC4D/TMO3	CRXD0		TS15	
H6		P54	MTIOC4B/TMCI1	CTXD0		TS16	
H7		PC2	MTIOC4B/TCLKA	RXD5/SMISO5/SSCL5/SSLA3/ IRRXD5	SDHI_D3	TS30	
H8		PB7/PC1	MTIOC3B/TIOCB5	TXD9/SMOSI9/SSDA9	SDHI_D2		

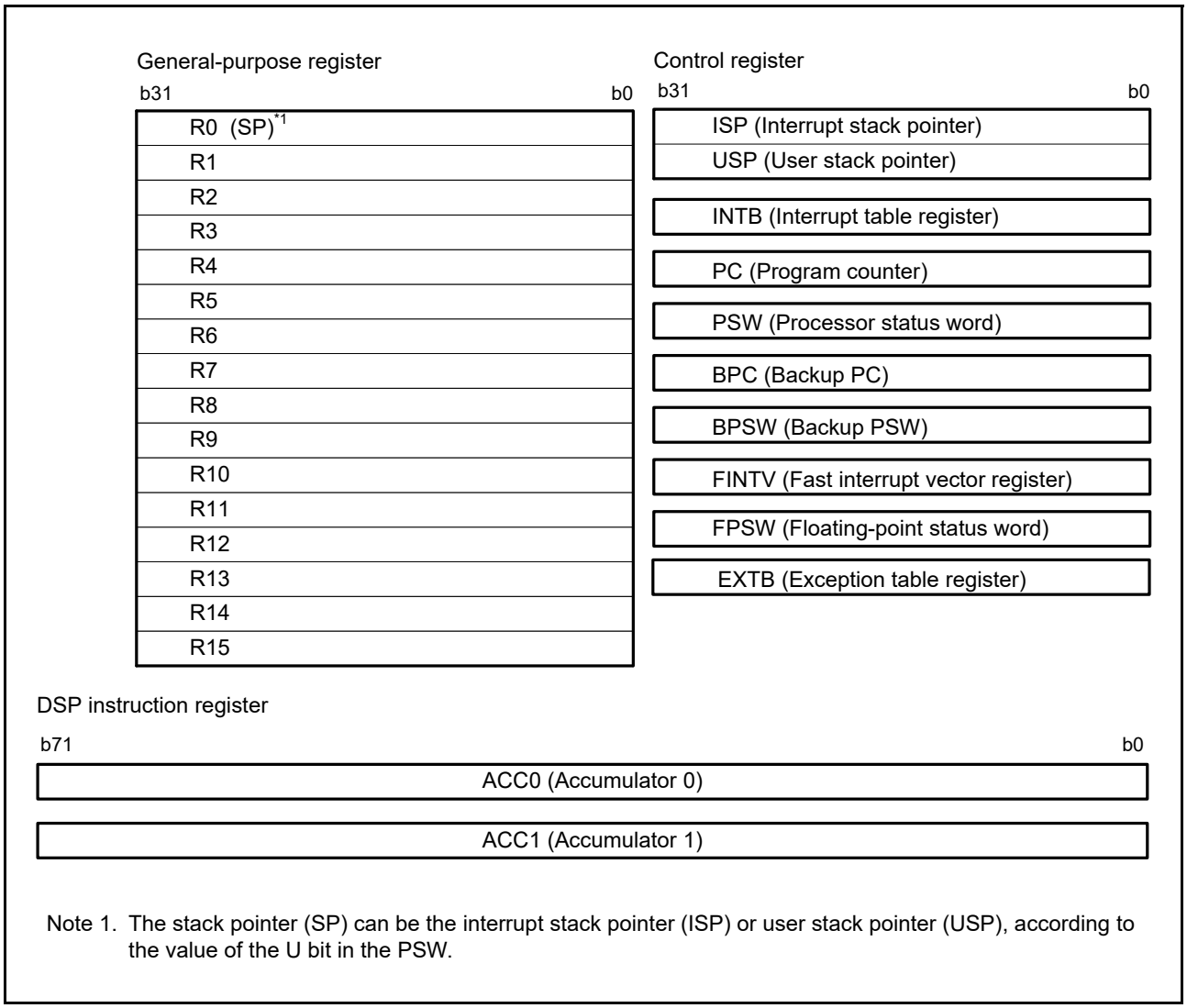
Note 1. RX230: PH0/CACREF, PH1/IRQ0/TMO0, PH2/IRQ1/TMRI0, PH3/TMCI0
RX231: VSS_USB, USB0_DP, USB0_DM, VCC_USB

Table 1.10 List of Pins and Pin Functions (48-Pin LFQFP/HWQFN) (1/2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, TPU, TMR, RTC, CMT, POE, CAC)	Communications (SCI, RSPI, RIIC, RSCAN, USB, SSI)	Memory Interface (SDHI)	Touch sensing	Others
1	VCL						
2	MD						FINED
3	RES#						
4	XTAL	P37					
5	VSS						
6	EXTAL	P36					
7	VCC						
8	UPSEL	P35					NMI
9		P31	MTIOC4D/TMCI2	CTS1#/RTS1#/SS1#/SSISCK0			IRQ1
10		P30	MTIOC4B/TMRI3/POE8#	RXD1/SMISO1/SSCL1/ AUDIO_MCLK			IRQ0/CMPOB3
11		P27	MTIOC2B/TMCI3	SCK1/SSIWS0		TS2	CVREFB3
12		P26	MTIOC2A/TMO1	TXD1/SMOSI1/SSDA1/ USB0_VBUSEN/SSIRXD0		TS3	CMPB3
13		P17	MTIOC3A/MTIOC3B/TMO1/ POE8#/TIOCB0/TCLKD	SCK1/MISOA/SDA/ SSITXD0			IRQ7/ CMPOB2
14		P16	MTIOC3C/MTIOC3D/TMO2/ TIOCB1/TCLKC	TXD1/SMOSI1/SSDA1/MOSIA/ SCL/USB0_VBUS/ USB0_VBUSEN/ USB0_OVRCURB			IRQ6/ADTRG0#
15		P15	MTIOC0B/MTCLKB/TMCI2/ TIOCB2/TCLKB	RXD1/SMISO1/SSCL1/CRXD0		TS12	IRQ5/CMPB2
16		P14	MTIOC3A/MTCLKA/TMRI2/ TIOCB5/TCLKA	CTS1#/RTS1#/SS1#/CTXD0/ USB0_OVRCURA		TS13	IRQ4/CVREFB2
17	VCC_USB*1	PH3*1	TMCI0*1				
18		PH2*1	TMRI0*1	USB0_DM*1			IRQ1*1
19		PH1*1	TMO0*1	USB0_DP*1			IRQ0*1
20	VSS_USB*1	PH0*1					CACREF*1
21	UB	PC7	MTIOC3A/MTCLKB/TMO2	TXD8/SMOSI8/SSDA8/MISOA			CACREF
22		PC6	MTIOC3C/MTCLKA/TMCI2	RXD8/SMISO8/SSCL8/MOSIA/ USB0_EXICEN		TS22	
23		PC5	MTIOC3B/MTCLKD/TMRI2	SCK8/RSPCKA/USB0_ID		TS23	
24		PC4	MTIOC3D/MTCLKC/TMCI1/ POE0#	SCK5/CTS8#/RTS8#/SS8#/ SSLA0		TSCAP	
25		PB5/PC3	MTIOC2A/MTIOC1B/TMRI1/ POE1#/TIOCB4	USB0_VBUS			
26		PB3/PC2	MTIOC0A/MTIOC4A/TMO0/ POE3#/TIOCD3/TCLKD	SCK6			
27		PB1/PC1	MTIOC0C/MTIOC4C/TMCI0/ TIOCB3	TXD6/SMOSI6/SSDA6			IRQ4/ CMPOB1
28	VCC						
29		PB0/PC0	MTIC5W/TIOCA3	RXD6/SMISO6/SSCL6/RSPCKA			
30	VSS						
31		PA6	MTIC5V/MTCLKB/TMCI3/POE2#/ TIOCA2	CTS5#/RTS5#/SS5#/MOSIA/ SSIWS0			
32		PA4	MTIC5U/MTCLKA/TMRI0/TIOCA1	TXD5/SMOSI5/SSDA5/SSLA0/ SSITXD0/IRTXD5			IRQ5 /CVREFB1
33		PA3	MTIOC0D/MTCLKD/TIOCD0/ TCLKB	RXD5/SMISO5/SSCL5/SSIRXD0/ IRRXD5			IRQ6 /CMPB1
34		PA1	MTIOC0B/MTCLKC/TIOCB0	SCK5/SSLA2/SSISCK0			
35		PE4	MTIOC4D/MTIOC1A				AN020/CMPA2/ CLKOUT
36		PE3	MTIOC4B/POE8#	CTS12#/RTS12#/AUDIO_MCLK			AN019/CLKOUT
37		PE2	MTIOC4A	RXD12/RXDX12/SSCL12			IRQ7/AN018/ CVREFB0
38		PE1	MTIOC4C	TXD12/TXDX12/SIOX12/SSDA12			AN017/CMPB0
39	VREFL						
40		P46					AN006
41	VREFH						

2. CPU

Figure 2.1 shows register set of the CPU.



Note 1. The stack pointer (SP) can be the interrupt stack pointer (ISP) or user stack pointer (USP), according to the value of the U bit in the PSW.

Figure 2.1 Register Set of the CPU

Table 4.1 List of I/O Registers (Address Order) (26/33)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK ≥ PCLK	ICLK <PCLK
000A 83DEh	RSCAN	Receive Rule Entry Register 5AH	GAFLIDH5	16	16	2 or 3 PCLKB	2 ICLK
000A 83DEh	RSCAN	Receive Buffer Register 3DH	RMDF33	16	16	2 or 3 PCLKB	2 ICLK
000A 83E0h	RSCAN	Receive Rule Entry Register 5BL	GAFLML5	16	16	2 or 3 PCLKB	2 ICLK
000A 83E0h	RSCAN	Receive Buffer Register 4AL	RMIDL4	16	16	2 or 3 PCLKB	2 ICLK
000A 83E2h	RSCAN	Receive Rule Entry Register 5BH	GAFLMH5	16	16	2 or 3 PCLKB	2 ICLK
000A 83E2h	RSCAN	Receive Buffer Register 4AH	RMIDH4	16	16	2 or 3 PCLKB	2 ICLK
000A 83E4h	RSCAN	Receive Rule Entry Register 5CL	GAFLPL5	16	16	2 or 3 PCLKB	2 ICLK
000A 83E4h	RSCAN	Receive Buffer Register 4BL	RMTS4	16	16	2 or 3 PCLKB	2 ICLK
000A 83E6h	RSCAN	Receive Rule Entry Register 5CH	GAFLPH5	16	16	2 or 3 PCLKB	2 ICLK
000A 83E6h	RSCAN	Receive Buffer Register 4BH	RMPTR4	16	16	2 or 3 PCLKB	2 ICLK
000A 83E8h	RSCAN	Receive Rule Entry Register 6AL	GAFLIDL6	16	16	2 or 3 PCLKB	2 ICLK
000A 83E8h	RSCAN	Receive Buffer Register 4CL	RMDF04	16	16	2 or 3 PCLKB	2 ICLK
000A 83EAh	RSCAN	Receive Rule Entry Register 6AH	GAFLIDH6	16	16	2 or 3 PCLKB	2 ICLK
000A 83EAh	RSCAN	Receive Buffer Register 4CH	RMDF14	16	16	2 or 3 PCLKB	2 ICLK
000A 83ECh	RSCAN	Receive Rule Entry Register 6BL	GAFLML6	16	16	2 or 3 PCLKB	2 ICLK
000A 83ECh	RSCAN	Receive Buffer Register 4DL	RMDF24	16	16	2 or 3 PCLKB	2 ICLK
000A 83EEh	RSCAN	Receive Rule Entry Register 6BH	GAFLMH6	16	16	2 or 3 PCLKB	2 ICLK
000A 83EEh	RSCAN	Receive Buffer Register 4DH	RMDF34	16	16	2 or 3 PCLKB	2 ICLK
000A 83F0h	RSCAN	Receive Rule Entry Register 6CL	GAFLPL6	16	16	2 or 3 PCLKB	2 ICLK
000A 83F0h	RSCAN	Receive Buffer Register 5AL	RMIDL5	16	16	2 or 3 PCLKB	2 ICLK
000A 83F2h	RSCAN	Receive Rule Entry Register 6CH	GAFLPH6	16	16	2 or 3 PCLKB	2 ICLK
000A 83F2h	RSCAN	Receive Buffer Register 5AH	RMIDH5	16	16	2 or 3 PCLKB	2 ICLK
000A 83F4h	RSCAN	Receive Rule Entry Register 7AL	GAFLIDL7	16	16	2 or 3 PCLKB	2 ICLK
000A 83F4h	RSCAN	Receive Buffer Register 5BL	RMTS5	16	16	2 or 3 PCLKB	2 ICLK
000A 83F6h	RSCAN	Receive Rule Entry Register 7AH	GAFLIDH7	16	16	2 or 3 PCLKB	2 ICLK
000A 83F6h	RSCAN	Receive Buffer Register 5BH	RMPTR5	16	16	2 or 3 PCLKB	2 ICLK
000A 83F8h	RSCAN	Receive Rule Entry Register 7BL	GAFLML7	16	16	2 or 3 PCLKB	2 ICLK
000A 83F8h	RSCAN	Receive Buffer Register 5CL	RMDF05	16	16	2 or 3 PCLKB	2 ICLK
000A 83FAh	RSCAN	Receive Rule Entry Register 7BH	GAFLMH7	16	16	2 or 3 PCLKB	2 ICLK
000A 83FAh	RSCAN	Receive Buffer Register 5CH	RMDF15	16	16	2 or 3 PCLKB	2 ICLK
000A 83FCh	RSCAN	Receive Rule Entry Register 7CL	GAFLPL7	16	16	2 or 3 PCLKB	2 ICLK
000A 83FCh	RSCAN	Receive Buffer Register 5DL	RMDF25	16	16	2 or 3 PCLKB	2 ICLK
000A 83FEh	RSCAN	Receive Rule Entry Register 7CH	GAFLPH7	16	16	2 or 3 PCLKB	2 ICLK
000A 83FEh	RSCAN	Receive Buffer Register 5DH	RMDF35	16	16	2 or 3 PCLKB	2 ICLK
000A 8400h	RSCAN	Receive Rule Entry Register 8AL	GAFLIDL8	16	16	2 or 3 PCLKB	2 ICLK
000A 8400h	RSCAN	Receive Buffer Register 6AL	RMIDL6	16	16	2 or 3 PCLKB	2 ICLK
000A 8402h	RSCAN	Receive Rule Entry Register 8AH	GAFLIDH8	16	16	2 or 3 PCLKB	2 ICLK
000A 8402h	RSCAN	Receive Buffer Register 6AH	RMIDH6	16	16	2 or 3 PCLKB	2 ICLK
000A 8404h	RSCAN	Receive Rule Entry Register 8BL	GAFLML8	16	16	2 or 3 PCLKB	2 ICLK
000A 8404h	RSCAN	Receive Buffer Register 6BL	RMTS6	16	16	2 or 3 PCLKB	2 ICLK
000A 8406h	RSCAN	Receive Rule Entry Register 8BH	GAFLMH8	16	16	2 or 3 PCLKB	2 ICLK
000A 8406h	RSCAN	Receive Buffer Register 6BH	RMPTR6	16	16	2 or 3 PCLKB	2 ICLK
000A 8408h	RSCAN	Receive Rule Entry Register 8CL	GAFLPL8	16	16	2 or 3 PCLKB	2 ICLK
000A 8408h	RSCAN	Receive Buffer Register 6CL	RMDF06	16	16	2 or 3 PCLKB	2 ICLK
000A 840Ah	RSCAN	Receive Rule Entry Register 8CH	GAFLPH8	16	16	2 or 3 PCLKB	2 ICLK
000A 840Ah	RSCAN	Receive Buffer Register 6CH	RMDF16	16	16	2 or 3 PCLKB	2 ICLK
000A 840Ch	RSCAN	Receive Rule Entry Register 9AL	GAFLIDL9	16	16	2 or 3 PCLKB	2 ICLK
000A 840Ch	RSCAN	Receive Buffer Register 6DL	RMDF26	16	16	2 or 3 PCLKB	2 ICLK
000A 840Eh	RSCAN	Receive Rule Entry Register 9AH	GAFLIDH9	16	16	2 or 3 PCLKB	2 ICLK
000A 840Eh	RSCAN	Receive Buffer Register 6DH	RMDF36	16	16	2 or 3 PCLKB	2 ICLK
000A 8410h	RSCAN	Receive Rule Entry Register 9BL	GAFLML9	16	16	2 or 3 PCLKB	2 ICLK
000A 8410h	RSCAN	Receive Buffer Register 7AL	RMIDL7	16	16	2 or 3 PCLKB	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (30/33)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK ≥ PCLK	ICLK <PCLK
000A 85EAh	RSCAN0	Transmit/Receive FIFO Access Register 0CH	CFDF10	16	16	2 or 3 PCLKB	2 ICLK
000A 85EAh	RSCAN	RAM Test Register 53	RPGACC53	16	16	2 or 3 PCLKB	2 ICLK
000A 85ECh	RSCAN0	Transmit/Receive FIFO Access Register 0DL	CFDF20	16	16	2 or 3 PCLKB	2 ICLK
000A 85ECh	RSCAN	RAM Test Register 54	RPGACC54	16	16	2 or 3 PCLKB	2 ICLK
000A 85EEh	RSCAN0	Transmit/Receive FIFO Access Register 0DH	CFDF30	16	16	2 or 3 PCLKB	2 ICLK
000A 85EEh	RSCAN	RAM Test Register 55	RPGACC55	16	16	2 or 3 PCLKB	2 ICLK
000A 85F0h to 000A 85FEh	RSCAN	RAM Test Register 56 to RAM Test Register 63	RPGACC56 to RPGACC63	16	16	2 or 3 PCLKB	2 ICLK
000A 8600h	RSCAN0	Transmit Buffer Register 0AL	TMIDL0	16	16	2 or 3 PCLKB	2 ICLK
000A 8600h	RSCAN	RAM Test Register 64	RPGACC64	16	16	2 or 3 PCLKB	2 ICLK
000A 8602h	RSCAN0	Transmit Buffer Register 0AH	TMIDH0	16	16	2 or 3 PCLKB	2 ICLK
000A 8602h	RSCAN	RAM Test Register 65	RPGACC65	16	16	2 or 3 PCLKB	2 ICLK
000A 8604h	RSCAN	RAM Test Register 66	RPGACC66	16	16	2 or 3 PCLKB	2 ICLK
000A 8606h	RSCAN0	Transmit Buffer Register 0BH	TMPTR0	16	16	2 or 3 PCLKB	2 ICLK
000A 8606h	RSCAN	RAM Test Register 67	RPGACC67	16	16	2 or 3 PCLKB	2 ICLK
000A 8608h	RSCAN0	Transmit Buffer Register 0CL	TMDF00	16	16	2 or 3 PCLKB	2 ICLK
000A 8608h	RSCAN	RAM Test Register 68	RPGACC68	16	16	2 or 3 PCLKB	2 ICLK
000A 860Ah	RSCAN0	Transmit Buffer Register 0CH	TMDF10	16	16	2 or 3 PCLKB	2 ICLK
000A 860Ah	RSCAN	RAM Test Register 69	RPGACC69	16	16	2 or 3 PCLKB	2 ICLK
000A 860Ch	RSCAN0	Transmit Buffer Register 0DL	TMDF20	16	16	2 or 3 PCLKB	2 ICLK
000A 860Ch	RSCAN	RAM Test Register 70	RPGACC70	16	16	2 or 3 PCLKB	2 ICLK
000A 860Eh	RSCAN0	Transmit Buffer Register 0DH	TMDF30	16	16	2 or 3 PCLKB	2 ICLK
000A 860Eh	RSCAN	RAM Test Register 71	RPGACC71	16	16	2 or 3 PCLKB	2 ICLK
000A 8610h	RSCAN0	Transmit Buffer Register 1AL	TMIDL1	16	16	2 or 3 PCLKB	2 ICLK
000A 8610h	RSCAN	RAM Test Register 72	RPGACC72	16	16	2 or 3 PCLKB	2 ICLK
000A 8612h	RSCAN0	Transmit Buffer Register 1AH	TMIDH1	16	16	2 or 3 PCLKB	2 ICLK
000A 8612h	RSCAN	RAM Test Register 73	RPGACC73	16	16	2 or 3 PCLKB	2 ICLK
000A 8614h	RSCAN	RAM Test Register 74	RPGACC74	16	16	2 or 3 PCLKB	2 ICLK
000A 8616h	RSCAN0	Transmit Buffer Register 1BH	TMPTR1	16	16	2 or 3 PCLKB	2 ICLK
000A 8616h	RSCAN	RAM Test Register 75	RPGACC75	16	16	2 or 3 PCLKB	2 ICLK
000A 8618h	RSCAN0	Transmit Buffer Register 1CL	TMDF01	16	16	2 or 3 PCLKB	2 ICLK
000A 8618h	RSCAN	RAM Test Register 76	RPGACC76	16	16	2 or 3 PCLKB	2 ICLK
000A 861Ah	RSCAN0	Transmit Buffer Register 1CH	TMDF11	16	16	2 or 3 PCLKB	2 ICLK
000A 861Ah	RSCAN	RAM Test Register 77	RPGACC77	16	16	2 or 3 PCLKB	2 ICLK
000A 861Ch	RSCAN0	Transmit Buffer Register 1DL	TMDF21	16	16	2 or 3 PCLKB	2 ICLK
000A 861Ch	RSCAN	RAM Test Register 78	RPGACC78	16	16	2 or 3 PCLKB	2 ICLK
000A 861Eh	RSCAN0	Transmit Buffer Register 1DH	TMDF31	16	16	2 or 3 PCLKB	2 ICLK
000A 861Eh	RSCAN	RAM Test Register 79	RPGACC79	16	16	2 or 3 PCLKB	2 ICLK
000A 8620h	RSCAN0	Transmit Buffer Register 2AL	TMIDL2	16	16	2 or 3 PCLKB	2 ICLK
000A 8620h	RSCAN	RAM Test Register 80	RPGACC80	16	16	2 or 3 PCLKB	2 ICLK
000A 8622h	RSCAN0	Transmit Buffer Register 2AH	TMIDH2	16	16	2 or 3 PCLKB	2 ICLK
000A 8622h	RSCAN	RAM Test Register 81	RPGACC81	16	16	2 or 3 PCLKB	2 ICLK
000A 8624h	RSCAN	RAM Test Register 82	RPGACC82	16	16	2 or 3 PCLKB	2 ICLK
000A 8626h	RSCAN0	Transmit Buffer Register 2BH	TMPTR2	16	16	2 or 3 PCLKB	2 ICLK
000A 8626h	RSCAN	RAM Test Register 83	RPGACC83	16	16	2 or 3 PCLKB	2 ICLK
000A 8628h	RSCAN0	Transmit Buffer Register 2CL	TMDF02	16	16	2 or 3 PCLKB	2 ICLK
000A 8628h	RSCAN	RAM Test Register 84	RPGACC84	16	16	2 or 3 PCLKB	2 ICLK
000A 862Ah	RSCAN0	Transmit Buffer Register 2CH	TMDF12	16	16	2 or 3 PCLKB	2 ICLK
000A 862Ah	RSCAN	RAM Test Register 85	RPGACC85	16	16	2 or 3 PCLKB	2 ICLK
000A 862Ch	RSCAN0	Transmit Buffer Register 2DL	TMDF22	16	16	2 or 3 PCLKB	2 ICLK
000A 862Ch	RSCAN	RAM Test Register 86	RPGACC86	16	16	2 or 3 PCLKB	2 ICLK
000A 862Eh	RSCAN0	Transmit Buffer Register 2DH	TMDF32	16	16	2 or 3 PCLKB	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (33/33)

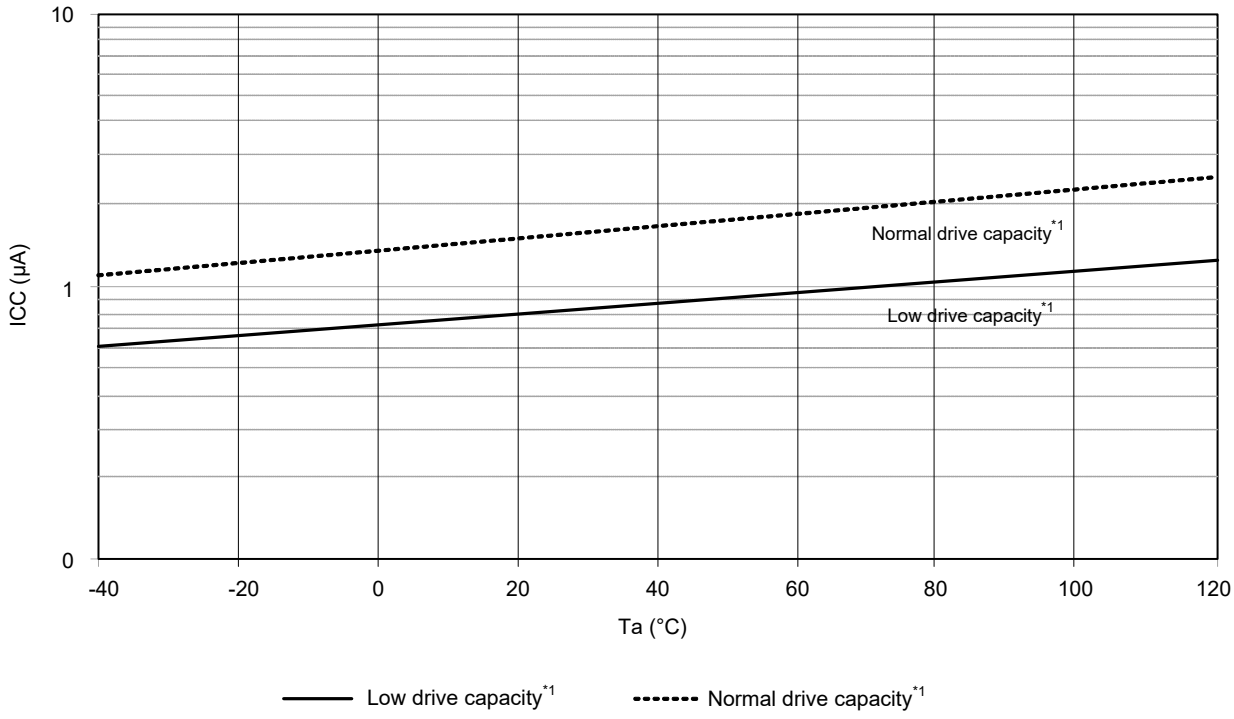
Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK ≥ PCLK	ICLK <PCLK
000D 0C80h	MTU5	Timer Counter U	TCNTU	16	16	2 or 3 PCLKA	2 ICLK
000D 0C82h	MTU5	Timer General Register U	TGRU	16	16	2 or 3 PCLKA	2 ICLK
000D 0C84h	MTU5	Timer Control Register U	TCRU	8	8	2 or 3 PCLKA	2 ICLK
000D 0C86h	MTU5	Timer I/O Control Register U	TIORU	8	8	2 or 3 PCLKA	2 ICLK
000D 0C90h	MTU5	Timer Counter V	TCNTV	16	16	2 or 3 PCLKA	2 ICLK
000D 0C92h	MTU5	Timer General Register V	TGRV	16	16	2 or 3 PCLKA	2 ICLK
000D 0C94h	MTU5	Timer Control Register V	TCRV	8	8	2 or 3 PCLKA	2 ICLK
000D 0C96h	MTU5	Timer I/O Control Register V	TIORV	8	8	2 or 3 PCLKA	2 ICLK
000D 0CA0h	MTU5	Timer Counter W	TCNTW	16	16	2 or 3 PCLKA	2 ICLK
000D 0CA2h	MTU5	Timer General Register W	TGRW	16	16	2 or 3 PCLKA	2 ICLK
000D 0CA4h	MTU5	Timer Control Register W	TCRW	8	8	2 or 3 PCLKA	2 ICLK
000D 0CA6h	MTU5	Timer I/O Control Register W	TIORW	8	8	2 or 3 PCLKA	2 ICLK
000D 0CB2h	MTU5	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKA	2 ICLK
000D 0CB4h	MTU5	Timer Start Register	TSTR	8	8	2 or 3 PCLKA	2 ICLK
000D 0CB6h	MTU5	Timer Compare Match Clear Register	TCNTCMPCLR	8	8	2 or 3 PCLKA	2 ICLK
007F C090h	FLASH	E2 DataFlash Control Register	DFLCTL	8	8	2 or 3 FCLK	2 ICLK
007F C0ACh	TEMPSA	Temperature Sensor Calibration Data Register L	TSCDRL	8	8	2 or 3 PCLKA	2ICLK
007F C0ADh	TEMPSA	Temperature Sensor Calibration Data Register H	TSCDRH	8	8	2 or 3 PCLKA	2ICLK
007F C100h	FLASH	Flash P/E Mode Control Register	FPMCR	8	8	2 or 3 FCLK	2 ICLK
007F C104h	FLASH	Flash Area Select Register	FASR	8	8	2 or 3 FCLK	2 ICLK
007F C108h	FLASH	Flash Processing Start Address Register L	FSARL	16	16	2 or 3 FCLK	2 ICLK
007F C110h	FLASH	Flash Processing Start Address Register H	FSARH	16	16	2 or 3 FCLK	2 ICLK
007F C114h	FLASH	Flash Control Register	FCR	8	8	2 or 3 FCLK	2 ICLK
007F C118h	FLASH	Flash Processing End Address Register L	FEARL	16	16	2 or 3 FCLK	2 ICLK
007F C120h	FLASH	Flash Processing End Address Register H	FEARH	16	16	2 or 3 FCLK	2 ICLK
007F C124h	FLASH	Flash Reset Register	FRESETR	8	8	2 or 3 FCLK	2 ICLK
007F C12Ch	FLASH	Flash Status Register 1	FSTATR1	8	8	2 or 3 FCLK	2 ICLK
007F C130h	FLASH	Flash Write Buffer Register 0	FWB0	16	16	2 or 3 FCLK	2 ICLK
007F C138h	FLASH	Flash Write Buffer Register 1	FWB1	16	16	2 or 3 FCLK	2 ICLK
007F C140h	FLASH	Flash Write Buffer Register 2	FWB2	16	16	2 or 3 FCLK	2 ICLK
007F C144h	FLASH	Flash Write Buffer Register 3	FWB3	16	16	2 or 3 FCLK	2 ICLK
007F C180h	FLASH	Protection Unlock Register	FPR	8	8	2 or 3 FCLK	2 ICLK
007F C184h	FLASH	Protection Unlock Status Register	FPSR	8	8	2 or 3 FCLK	2 ICLK
007F C1C0h	FLASH	Flash Start-Up Setting Monitor Register	FSCMR	16	16	2 or 3 FCLK	2 ICLK
007F C1C8h	FLASH	Flash Access Window Start Address Monitor Register	FAWSMR	16	16	2 or 3 FCLK	2 ICLK
007F C1D0h	FLASH	Flash Access Window End Address Monitor Register	FAWEMR	16	16	2 or 3 FCLK	2 ICLK
007F C1D8h	FLASH	Flash Initial Setting Register	FISR	8	8	2 or 3 FCLK	2 ICLK
007F C1DCh	FLASH	Flash Extra Area Control Register	FEXCR	8	8	2 or 3 FCLK	2 ICLK
007F C1E0h	FLASH	Flash Error Address Monitor Register L	FEAML	16	16	2 or 3 FCLK	2 ICLK
007F C1E8h	FLASH	Flash Error Address Monitor Register H	FEAMH	8	8	2 or 3 FCLK	2 ICLK
007F C1F0h	FLASH	Flash Status Register 0	FSTATR0	8	8	2 or 3 FCLK	2 ICLK
007F C350h	FLASHCONST	Unique ID Register 0	UIDR0	32	32	2 or 3 FCLK	2 ICLK
007F C354h	FLASHCONST	Unique ID Register 1	UIDR1	32	32	2 or 3 FCLK	2 ICLK
007F C358h	FLASHCONST	Unique ID Register 2	UIDR2	32	32	2 or 3 FCLK	2 ICLK
007F C35Ch	FLASHCONST	Unique ID Register 3	UIDR3	32	32	2 or 3 FCLK	2 ICLK
007F FFB2h	FLASH	Flash P/E Mode Entry Register	FENTRYR	16	16	2 or 3 FCLK	2 ICLK

Note 1. Odd addresses cannot be accessed in 16-bit units. Table 26.4 lists register allocation for 16-bit access in the User's Manual: Hardware.
Note 2. When the register is accessed while the USB is operating, a delay may be generated in accessing.

Table 5.7 DC Characteristics (5)

Conditions: 1.8 V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item					Symbol	Typ. *4	Max.	Unit	Test Conditions
Supply current *1	High-speed operating mode	Normal operating mode	No peripheral operation*2	ICLK = 54 MHz	I_{CC}	6.5	—	mA	
				ICLK = 32 MHz		4.1	—		
				ICLK = 16 MHz		2.9	—		
				ICLK = 8 MHz		2.2	—		
				ICLK = 4 MHz		1.9	—		
			All peripheral operation: Normal	ICLK = 54 MHz*11		26.5	—		
				ICLK = 32 MHz*3		21.0	—		
				ICLK = 16 MHz*3		11.8	—		
				ICLK = 8 MHz*3		6.6	—		
				ICLK = 4 MHz*3		4.2	—		
			All peripheral operation: Max.	ICLK = 54 MHz*11		—	53.3		
				ICLK = 32 MHz*3		—	40.8		
			Increase due to operation of the Trusted Secure IP	PCLKB = 32 MHz		—	2		
		Sleep mode	No peripheral operation*2	ICLK = 54 MHz		3.5	—		
				ICLK = 32 MHz		2.4	—		
				ICLK = 16 MHz		1.9	—		
				ICLK = 8 MHz		1.6	—		
				ICLK = 4 MHz		1.5	—		
			All peripheral operation: Normal	ICLK = 54 MHz*11		13.4	—		
				ICLK = 32 MHz*3		12.5	—		
				ICLK = 16 MHz*3		7.3	—		
				ICLK = 8 MHz*3		4.6	—		
				ICLK = 4 MHz*3		3.3	—		
		Deep sleep mode	No peripheral operation*2	ICLK = 54 MHz		2.3	—		
				ICLK = 32 MHz		1.5	—		
				ICLK = 16 MHz		1.3	—		
				ICLK = 8 MHz		1.2	—		
				ICLK = 4 MHz		1.1	—		
			All peripheral operation: Normal	ICLK = 54 MHz*11		10.6	—		
				ICLK = 32 MHz*3		9.9	—		
				ICLK = 16 MHz*3		5.9	—		
				ICLK = 8 MHz*3		3.8	—		
				ICLK = 4 MHz*3		2.7	—		
		Increase during BGO operation*5				2.5	—		
	Middle-speed operating mode	Normal operating mode	No peripheral operation*6	ICLK = 12 MHz	I_{CC}	2.7	—	mA	
				ICLK = 8 MHz		1.8	—		
				ICLK = 4 MHz		1.4	—		
				ICLK = 1 MHz		1.1	—		
			All peripheral operation: Normal*7	ICLK = 12 MHz		9.6	—		
				ICLK = 8 MHz		6.2	—		
				ICLK = 4 MHz		3.8	—		
				ICLK = 1 MHz		2.3	—		



Note 1. Indicates the average of the typical samples through actual measurement during product evaluation.

Figure 5.6 Temperature Dependency of RTC Operation with VCC Off (Reference Data)

Table 5.10 DC Characteristics (8)

Conditions: 1.8 V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Permissible total power consumption*1	Pd	—	—	350	mW	D-version product
Permissible total power consumption*1	Pd	—	—	130	mW	G-version product

Note: Please contact a Renesas Electronics sales office for information on the derating of the G-version product. Derating is the systematic reduction of load to improve reliability.

Note 1. Total power dissipated by the entire chip (including output currents)

Table 5.23 Operating Frequency Value (Low-Speed Operating Mode)

Conditions: 1.8 V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VREFL0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Symbol	VCC			Unit
			1.8 V ≤ VCC < 2.4 V	2.4 V ≤ VCC < 2.7 V	2.7 V ≤ VCC ≤ 5.5 V	
Maximum operating frequency*3	System clock (ICLK)	f_{max}	32.768			kHz
	FlashIF clock (FCLK)*1		32.768			
	Peripheral module clock (PCLKA)		32.768			
	Peripheral module clock (PCLKB)		32.768			
	Peripheral module clock (PCLKD)*2		32.768			
	External bus clock (BCLK)		32.768			
	BCLK pin output		32.768			

Note 1. Programming and erasing the flash memory is impossible.
Note 2. The A/D converter cannot be used.
Note 3. The maximum operating frequency listed above does not include errors of the external oscillator. For details on the range for the guaranteed operation, see Table 5.26, Clock Timing.

Table 5.24 BCLK Clock Timing (1)

Conditions: 2.7 V ≤ VCC= VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VREFL0 = VSS_USB = 0 V,
fBCLK ≤ 32 MHz (BCLK pin output frequency ≤ 16 MHz), T_a = –40 to +105°C

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
BCLK pin output cycle time	t_{Bcyc}	62.5	—	—	ns	Figure 5.22
BCLK pin output high pulse width	t_{CH}	15	—	—	ns	
BCLK pin output low pulse width	t_{CL}	15	—	—	ns	
BCLK pin output rise time	t_{Cr}	—	—	12	ns	
BCLK pin output fall time	t_{Cf}	—	—	12	ns	

Table 5.25 BCLK Clock Timing (2)

Conditions: 1.8 V ≤ VCC = VCC_USB = AVCC0 < 2.7 V, VSS = AVSS0 = VREFL0 = VSS_USB = 0 V,
fBCLK ≤ 16 MHz (BCLK pin output frequency ≤ 8 MHz), T_a = –40 to +105°C

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
BCLK pin output cycle time	t_{Bcyc}	125	—	—	ns	Figure 5.22
BCLK pin output high pulse width	t_{CH}	30	—	—	ns	
BCLK pin output low pulse width	t_{CL}	30	—	—	ns	
BCLK pin output rise time	t_{Cr}	—	—	25	ns	
BCLK pin output fall time	t_{Cf}	—	—	25	ns	

5.3.4 Control Signal Timing

Table 5.33 Control Signal Timing

Conditions: 1.8 V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions	
NMI pulse width	t_{NMIW}	200	—	—	ns	NMI digital filter is disabled (NMIFLTE.NFLTEN = 0)	t_{Pcyc} × 2 ≤ 200 ns
		t_{Pcyc} × 2*1	—	—			t_{Pcyc} × 2 > 200 ns
		200	—	—		NMI digital filter is enabled (NMIFLTE.NFLTEN = 1)	t_{NMICK} × 3 ≤ 200 ns
		t_{NMICK} × 3.5*2	—	—			t_{NMICK} × 3 > 200 ns
IRQ pulse width	t_{IRQW}	200	—	—	ns	IRQ digital filter is disabled (IRQFLTE0.FLTENi = 0)	t_{Pcyc} × 2 ≤ 200 ns
		t_{Pcyc} × 2*1	—	—			t_{Pcyc} × 2 > 200 ns
		200	—	—		IRQ digital filter is enabled (IRQFLTE0.FLTENi = 1)	t_{IRQCK} × 3 ≤ 200 ns
		t_{IRQCK} × 3.5*3	—	—			t_{IRQCK} × 3 > 200 ns

Note: 200 ns minimum in software standby mode.
Note 1. t_{Pcyc} indicates the cycle of PCLKB.
Note 2. t_{NMICK} indicates the cycle of the NMI digital filter sampling clock.
Note 3. t_{IRQCK} indicates the cycle of the IRQi digital filter sampling clock (i = 0 to 7).

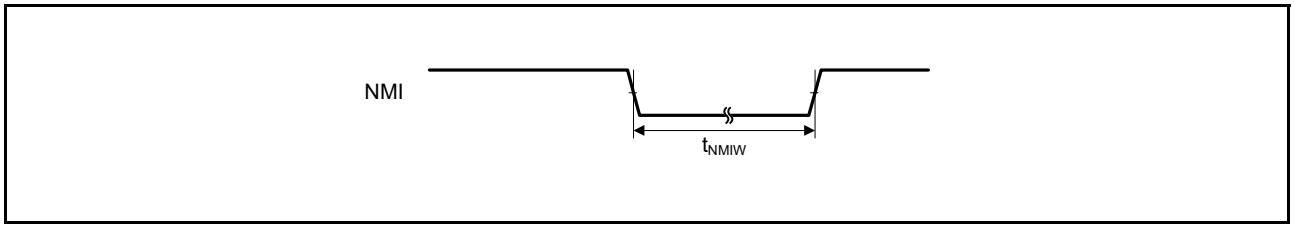


Figure 5.36 NMI Interrupt Input Timing

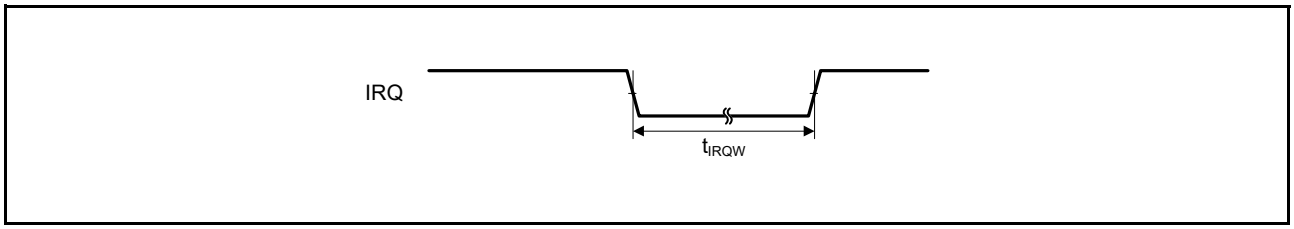


Figure 5.37 IRQ Interrupt Input Timing

Table 5.39 Timing of On-Chip Peripheral Modules (2)

Conditions: 1.8 V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C, C = 30 pF, when high-drive output is selected by the drive capacity control register

Item				Symbol	Min.	Max.	Unit	Test Conditions
RSPI	RSPCK clock cycle	Master		t_{SPcyc}	2	4096	t_{Pcyc}*1	Figure 5.54
		Slave			8	4096		
	RSPCK clock high pulse width	Master		t_{SPCKWH}	$(t_{SPcyc} - t_{SPCKr} - t_{SPCKf})/2 - 3$	—	ns	
		Slave			$(t_{SPcyc} - t_{SPCKr} - t_{SPCKf})/2$	—		
	RSPCK clock low pulse width	Master		t_{SPCKWL}	$(t_{SPcyc} - t_{SPCKr} - t_{SPCKf})/2 - 3$	—	ns	
		Slave			$(t_{SPcyc} - t_{SPCKr} - t_{SPCKf})/2$	—		
	RSPCK clock rise/fall time	Output	2.7 V or above	t_{SPCKr}, t_{SPCKf}	—	10	ns	
			1.8 V or above		—	15		
		Input			—	1	µs	
	Data input setup time	Master	2.7 V or above	t_{SU}	10	—	ns	Figure 5.55 to Figure 5.58
			1.8 V or above		30	—		
		Slave			$25 - t_{Pcyc}$	—		
	Data input hold time	Master	RSPCK set to a division ratio other than PCLKB divided by 2	t_H	t_{Pcyc}	—	ns	
			RSPCK set to PCLKB divided by 2	t_{HF}	0	—		
		Slave		t_H	$20 + 2 \times t_{Pcyc}$	—		
	SSL setup time	Master		t_{LEAD}	$-30 + N^{*2} \times t_{SPcyc}$	—	ns	
		Slave			2	—	t_{Pcyc}	
	SSL hold time	Master		t_{LAG}	$-30 + N^{*3} \times t_{SPcyc}$	—	ns	
		Slave			2	—	t_{Pcyc}	
	Data output delay time	Master	2.7 V or above	t_{OD}	—	14	ns	
			1.8 V or above		—	30		
		Slave	2.7 V or above		—	$3 \times t_{Pcyc} + 65$		
			1.8 V or above		—	$3 \times t_{Pcyc} + 105$		
	Data output hold time	Master		t_{OH}	0	—	ns	
		Slave			0	—		
	Successive transmission delay time	Master		t_{TD}	$t_{SPcyc} + 2 \times t_{Pcyc}$	$8 \times t_{SPcyc} + 2 \times t_{Pcyc}$	ns	
		Slave			$4 \times t_{Pcyc}$	—		
	MOSI and MISO rise/fall time	Output	2.7 V or above	t_{Dr}, t_{Df}	—	10	ns	
			1.8 V or above		—	15		
		Input			—	1	µs	
	SSL rise/fall time	Output	2.7 V or above	t_{SSLr}, t_{SSLf}	—	10	ns	
			1.8 V or above		—	15	ns	
		Input			—	1	µs	
	Slave access time		2.7 V or above	t_{SA}	—	6	t_{Pcyc}	Figure 5.57, Figure 5.58
			1.8 V or above		—	7		
	Slave output release time		2.7 V or above	t_{REL}	—	5	t_{Pcyc}	
			1.8 V or above		—	6		

Note 1. t_{Pcyc}: PCLK cycle
Note 2. N: An integer from 1 to 8 that can be set by the RSPI clock delay register (SPCKD)
Note 3. N: An integer from 1 to 8 that can be set by the RSPI slave select negation delay register (SSLND)

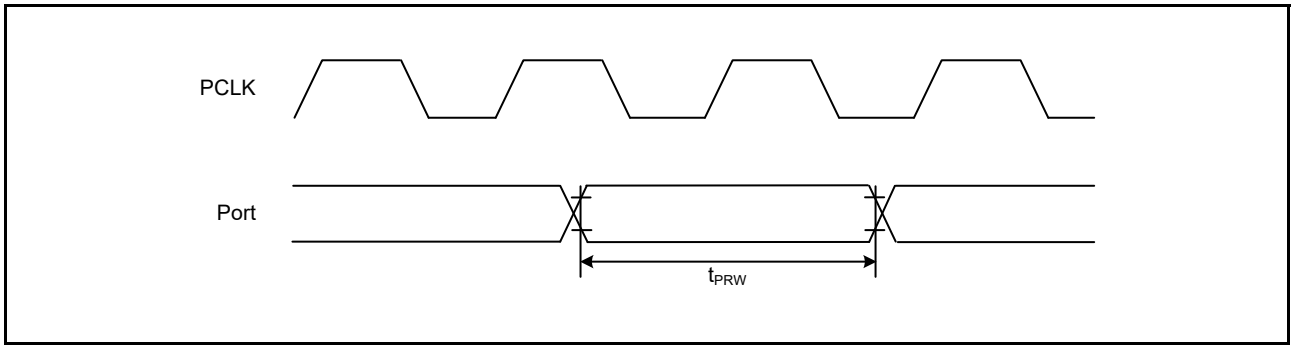


Figure 5.45 I/O Port Input Timing

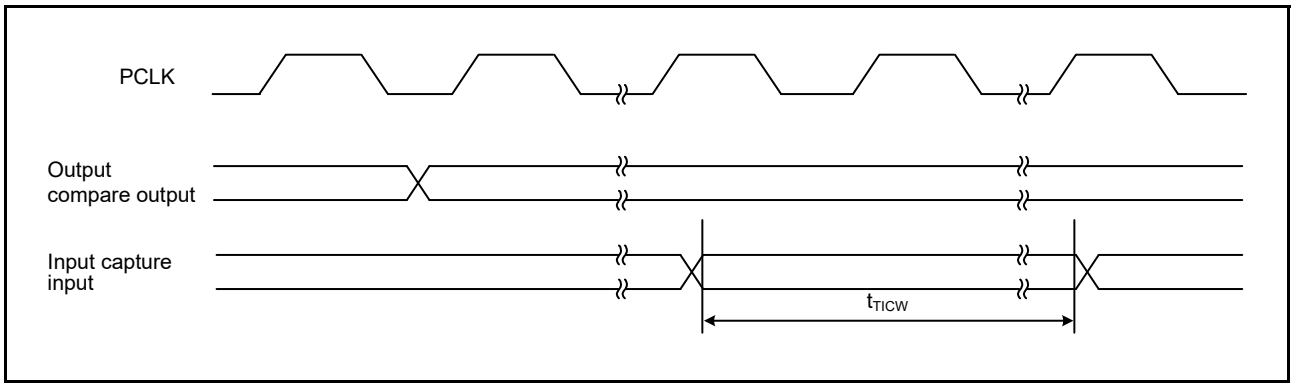


Figure 5.46 MTU2 Input/Output Timing

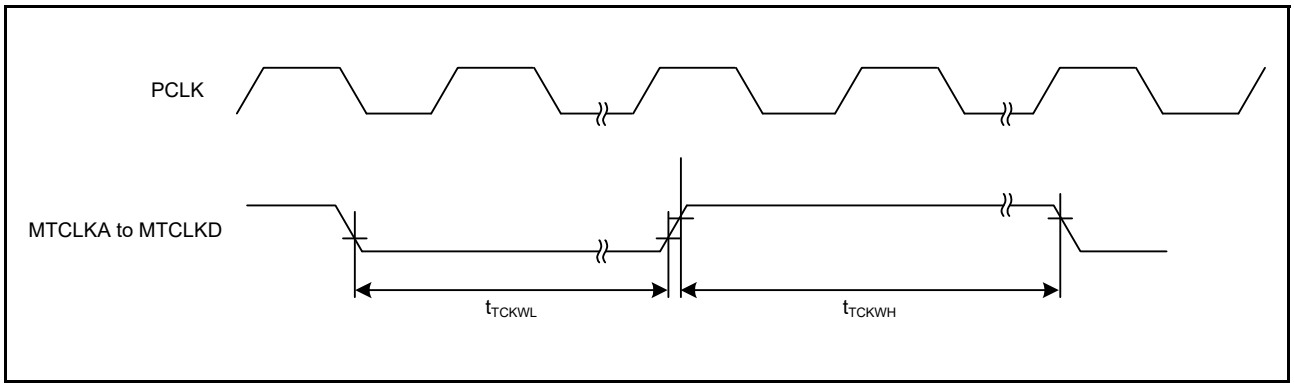


Figure 5.47 MTU2 Clock Input Timing

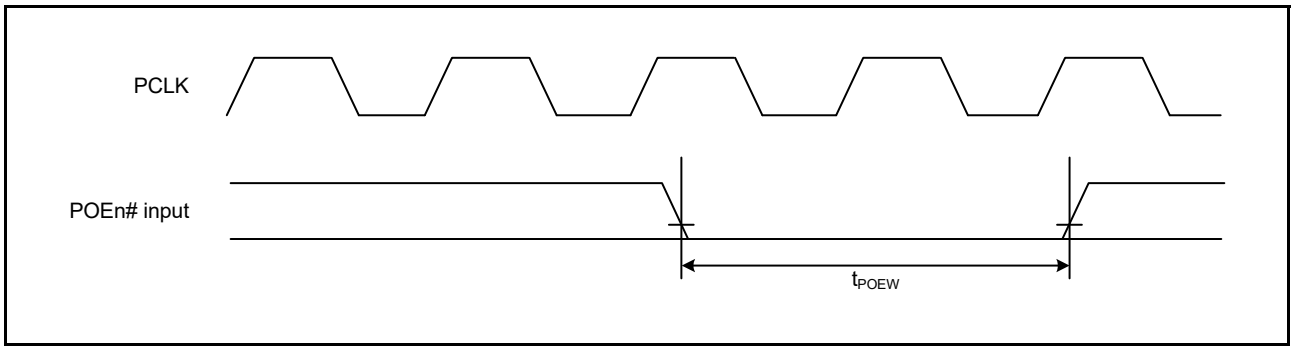


Figure 5.48 POE# Input Timing

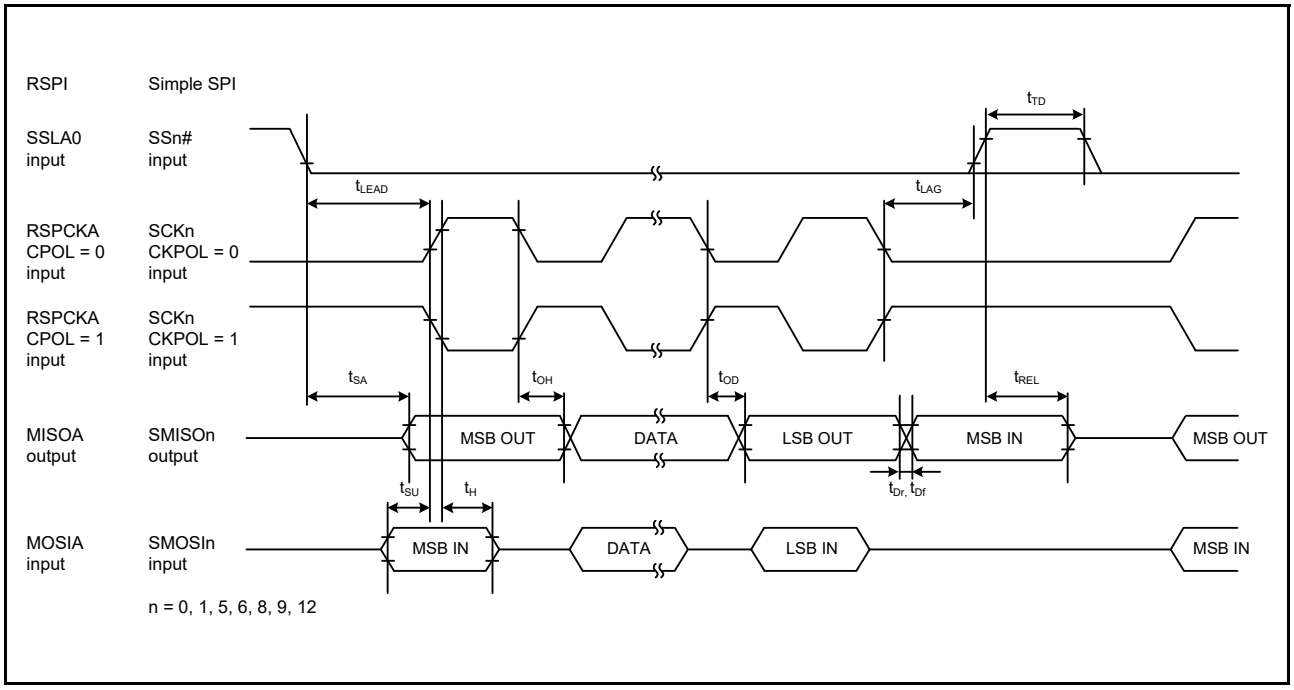


Figure 5.57 RSPI Timing (Slave, CPHA = 0) and Simple SPI Clock Timing (Slave, CKPH = 1)

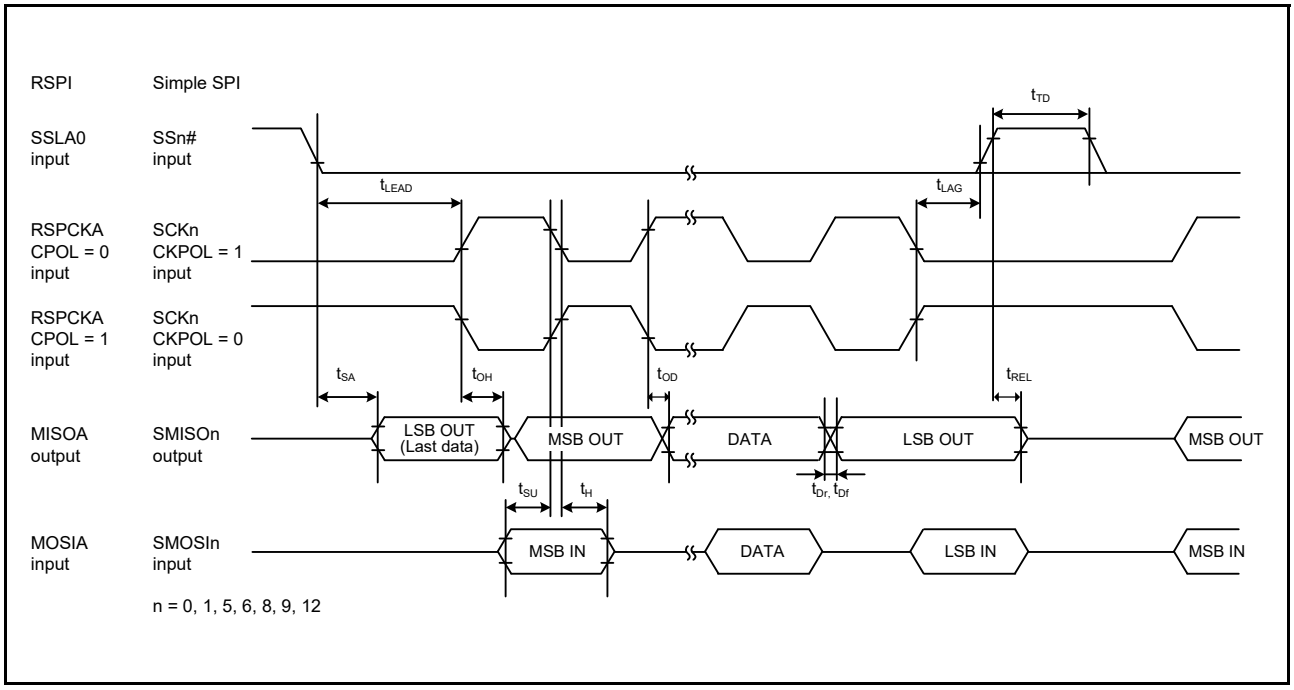


Figure 5.58 RSPI Timing (Slave, CPHA = 1) and Simple SPI Clock Timing (Slave, CKPH = 0)

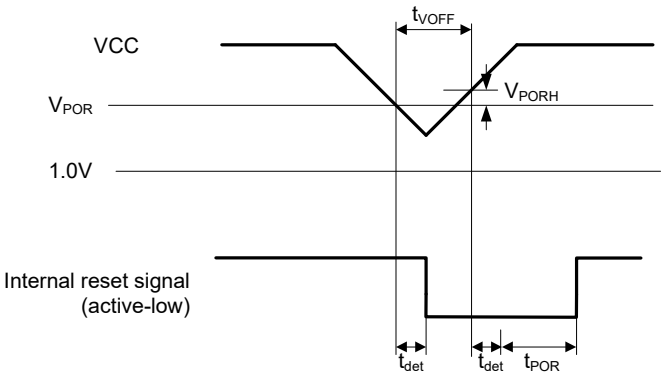
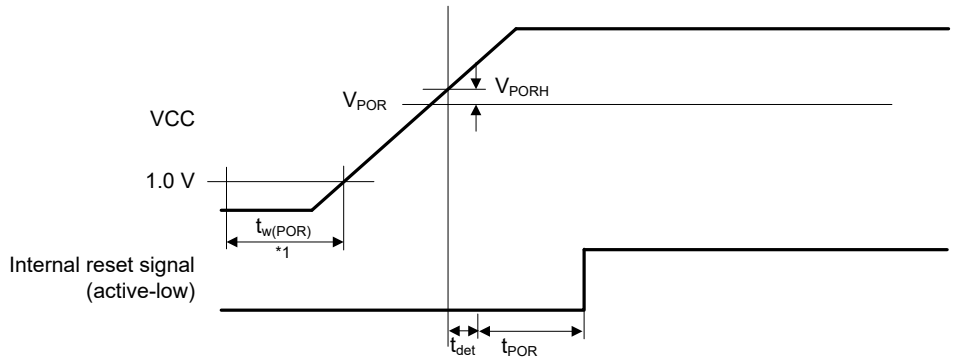


Figure 5.73 Voltage Detection Reset Timing



Note 1. $t_{w(POR)}$ is the time required for a power-on reset to be enabled while the external power VCC is being held below the valid voltage (1.0 V).
When turning the VCC on, maintain a voltage below 1.0V for at least 1.0ms.

Figure 5.74 Power-On Reset Timing

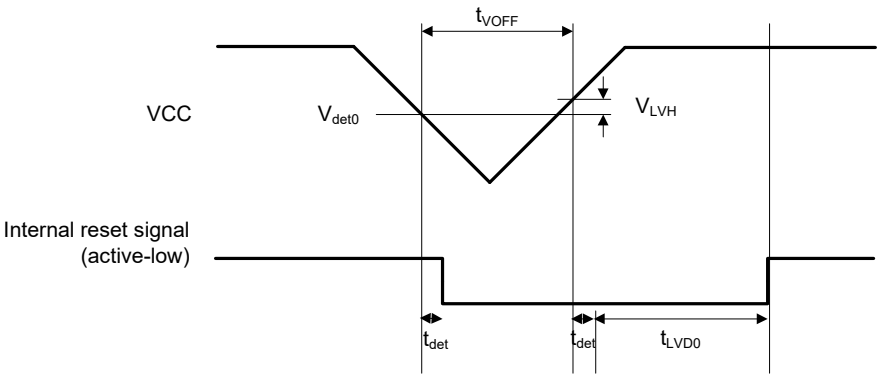


Figure 5.75 Voltage Detection Circuit Timing (Vdet0)

5.12 Battery Backup Function Characteristics

Table 5.61 Battery Backup Function Characteristics

Conditions: 1.8 V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5 V, 1.8 V ≤ VBATT ≤ 5.5 V, VSS = AVSS0 = VREFL0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Voltage level for switching to battery backup (falling)		$V_{DETBATT}$	1.99	2.09	2.19	V	Figure 5.79
Hysteresis width		V_{VBATTH}	—	100	—	mV	
VCC-off period for starting power supply switching		$t_{VOFFBATT}$	—	—	350	µs	
Allowable voltage change rising/falling gradient		dt/dVCC	1.0	—	—	ms/V	Figure 5.7
Level for detection of voltage drop on the VBATT pin (falling)	VBTLVDLVL[1:0] = 10b	$V_{DETBATLVD}$	2.11	2.20	2.29	V	Figure 5.79
	VBTLVDLVL[1:0] = 11b		1.87	2.00	2.13	V	
Hysteresis width for detection of voltage drop on the VBATT pin		$V_{BATLVDH}$	—	50	—	mV	

Note: The VCC-off period for starting power supply switching indicates the period in which VCC is below the minimum value of the voltage level for switching to battery backup ($V_{DETBATT}$).

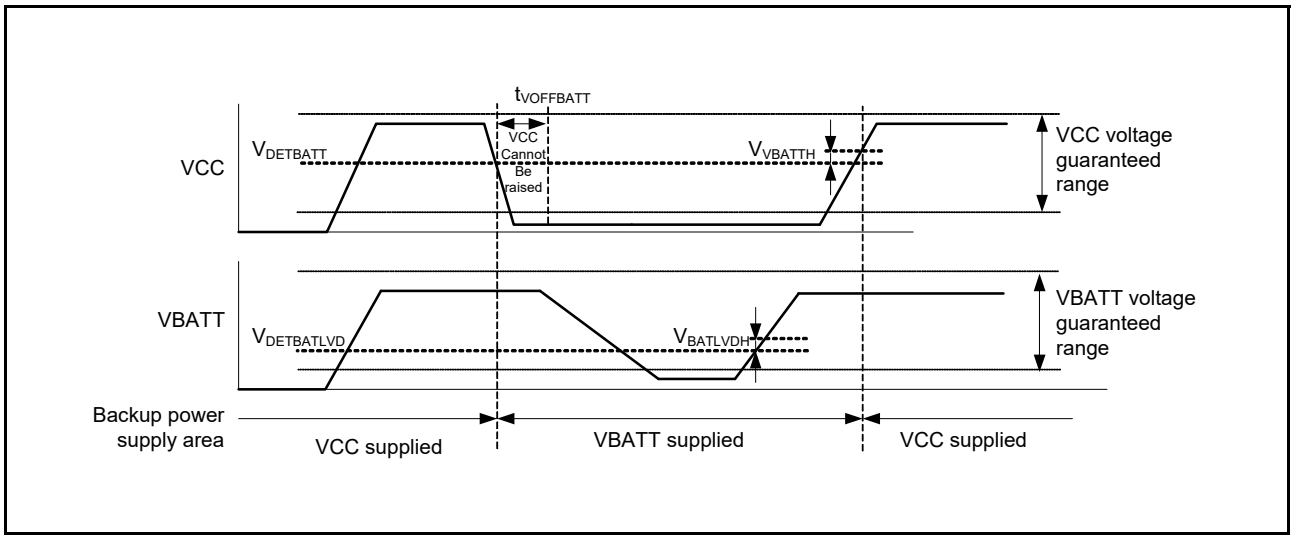


Figure 5.79 Battery Backup Function Characteristics

5.15 Usage Notes

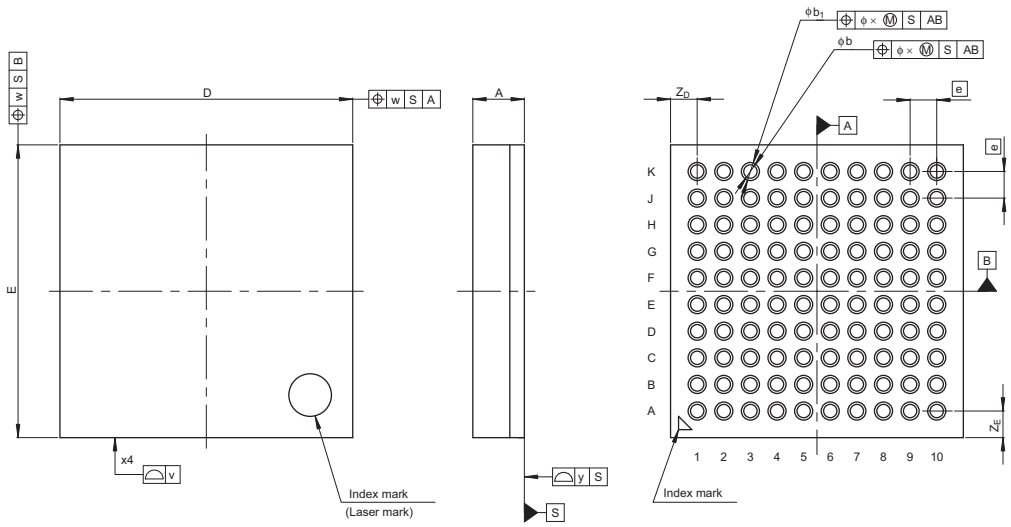
5.15.1 Connecting VCL Capacitor and Bypass Capacitors

This MCU integrates an internal voltage-down circuit, which is used for lowering the power supply voltage in the internal MCU automatically to the optimum level. A 4.7-µF capacitor needs to be connected between this internal voltage-down power supply (VCL pin) and the VSS pin. Figure 5.80 to Figure 5.82 shows how to connect external capacitors. Place an external capacitor close to the pins. Do not apply the power supply voltage to the VCL pin.
Insert a multilayer ceramic capacitor as a bypass capacitor between each pair of the power supply pins. Implement a bypass capacitor as closer to the MCU power supply pins as possible. Use a recommended value of 0.1 µF as the capacitance of the capacitors. For the capacitors related to crystal oscillation, see section 9, Clock Generation Circuit in the User's Manual: Hardware. For the capacitors related to analog modules, also see section 43, 12-Bit A/D Converter (S12ADE) in the User's Manual: Hardware.
For notes on designing the printed circuit board, see the descriptions of the application note, the Hardware Design Guide (R01AN1411EJ). The latest version can be downloaded from the Renesas Electronics website.

Appendix 1. Package Dimensions

Information on the latest version of the package dimensions or mountings has been displayed in “Packages” on Renesas Electronics Corporation website.

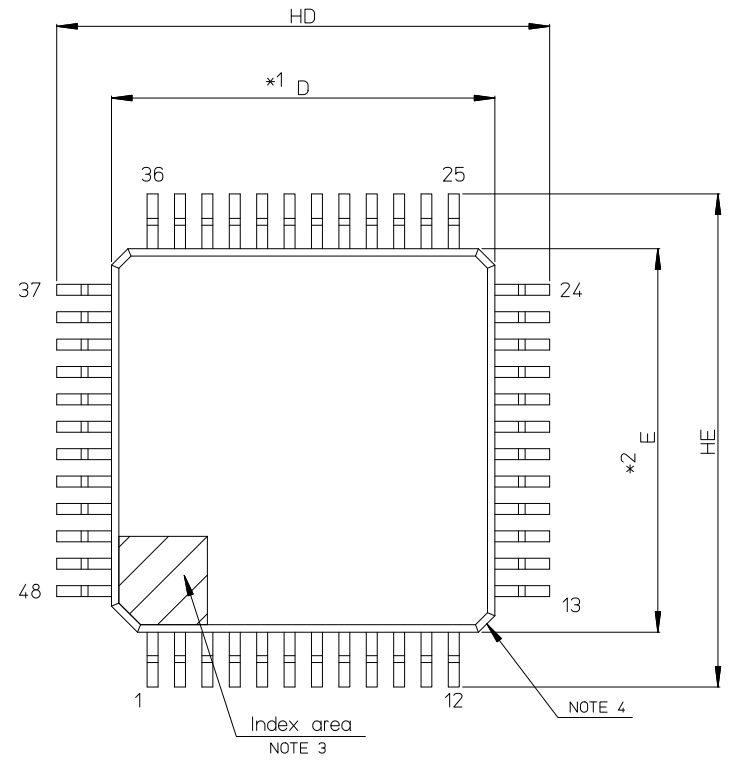
JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-TFLGA100-5.5x5.5-0.50	PTLG0100KA-A	100F0M	0.1g

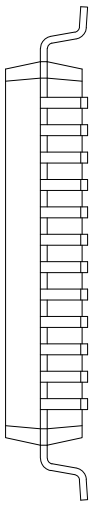


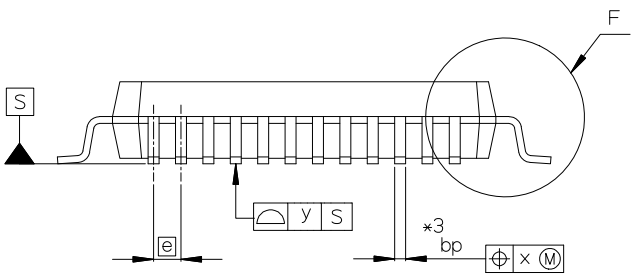
Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	—	5.5	—
E	—	5.5	—
v	—	—	0.15
w	—	—	0.20
A	—	—	1.05
e	—	0.5	—
b	0.21	0.25	0.29
b_1	0.29	0.34	0.39
x	—	—	0.08
y	—	—	0.08
Z_D	—	0.5	—
Z_E	—	0.5	—

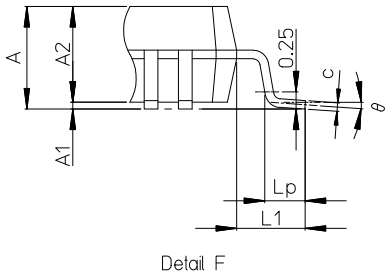
Figure A 100 -Pin TFLGA (PTLG0100KA-A)

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LFQFP48-7x7-0.50	PLQP0048KB-B	——	0.2g









Detail F

NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.
3. PIN 1 VISUAL INDEX FEATURE MAY VARY, BUT MUST BE LOCATED WITHIN THE HATCHED AREA.
4. CHAMFERS AT CORNERS ARE OPTIONAL, SIZE MAY VARY.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	6.9	7.0	7.1
E	6.9	7.0	7.1
A2	——	1.4	——
HD	8.8	9.0	9.2
HE	8.8	9.0	9.2
A	——	——	1.7
A1	0.05	——	0.15
bp	0.17	0.20	0.27
c	0.09	——	0.20
θ	0°	3.5°	8°
e	——	0.5	——
x	——	——	0.08
y	——	——	0.08
Lp	0.45	0.6	0.75
L1	——	1.0	——

Figure G 48 -Pin LFQFP (PLQP0048KB-B)